Form PTO-1595 (Rev. 03/ 01)	EET U.S. DEPARTMENT OF COMMERCE U.S. Patent and Trademark Office
OMB No. 0651-0027 (exp. 5/31/2002) 1 0	2533312 _{NLY} U.S. Patent and Trademark Office
To the Honorable Commissioner of Patents and	Trademarks: Please record the attached original documents or copy thereof
 Name of conveying party(ies): 	Name and address of receiving party(ies)
Masafumi Muramatsu (07/31/2003), Hayato I (07/31/2003), Kazumi Asada (01/08/2003), T	
Suzuki (08/07/2003), Toshitaka Hiraga (08/07	
and Tetsu Aoyama (08/07/2003)	7/2003), Internal Address: Street Address:
Additional name(s) of conveying party(ies) attached?	x No 6-7-35 Kitashinagawa
3. Nature of Conveyance:	Shinagawa-Ku Shinagawa-Ku Shinagawa-Ku City: Tokyo
x Assignment Merger C	7 7 7
Security Agreement Change of	of Name City: Tokyo
Other	Country: Japan Zip: 141-0001
Execution Date: see Box 1, conveying p	parties Additional name(s) & x Yes No
4. Anniination organization of the state of t	address(es) attached:
Application number(s) or patent number(s)	y.
	olication, the execution date of the new application is: August 7, 2003
A. Patent Application No.(s): This application A A A A A A A A A A A A A	B. Patent No.(s):
This application	
	l
Name and address of party to whom corresp concerning document should be mailed:	pondence 6. Total number of applications and patents involved: 1
Name: Ronald P. Kananen	7. Total fee (37 CFR 3.41) \$ 40.00
RADER, FISHMAN & GRAUER PLLC	
Internal Address: Atty. Dkt.: SON-2795/SH Street Address:	
1233 20th Street, N.W.	x Authorized to be charged to deposit accoun
Suite 501	Authorized to be charged to credit card (Form 2038 enclosed)
	8. Deposit account number:
City: State: Zip:	18-0013
Washington DC 20036	(Attach duplicate copy of this page if paying by deposit account)
D	O NOT USE THIS SPACE
9. Statement and signature.	
To the best of my knowledge and belief, the is a true copy of the original document.	foregoing information is true and correct and any attached copy
Ronald P. Kananen	August 14, 2003
Name of Person Signing	// Signature Date
Total number of pages including co	ver sheet, attachments, and documents: 6
1	
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Form PTO-1595 RECORDATION FORM COVER SHEET (continued)					
Additional Conveying Party(ies) (1. Continued):					
					1
					
Additional Assignees (2. Continued):					
Assignee Name:	EKC Technology I	K.K.			
Internal Address:					
Street Address: R&D Business Park Building D-3F, 2-1 Sakado 3-chome, Takatsu-ku Kawasaki-shi					
City: K	anagawa	Country:	Japan	Zip Code:	213-0012
Assignee Name: Internal Address:					
Street Address:					
oneet Address.					
City:		State:		Zip Code:	
Assignee Name:					
Internal Address:					
Street Address:					,
City:		State:		Zip Code:	
Additional Applications and/or Patents (4. Continued):					
Additional Patent A 4A. Continued:	Application Numbers		Additional Patent Nun 4B. Continued:	nbers	
Additional numbers attached? Yes No					

Docket No.:

Docket Number: SON-2795

ASSIGNMENT

WHEREAS, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

SEPARATION-MATERIAL COMPOSITION FOR PHOTO RESIST AND MANUFACTURING METHOD

OF SEMICONDUCTOR DEVICE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation., located and doing business at 7-35 Kitashinagawa 6-Chome, Shinagawa-ku, Tokyo, JAPAN and EKC Technology K.K., located and doing business at R&D Business Park Building D-3F, 2-1 Sakado 3-Chome, Takatsu-ku, Kawasaki-Shi, Kanagawa, 213-0012, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:_____, Filing Date: ______.

This assignment executed on the dates indicated below.

Masafumi MURAMATSU Name of first inventor

Kanagawa, Japan Residence of first inventor

masafami Muramotru

Signature of first inventor

07/31/2003 Date of this assignment

Havato IWAMOTO Name of second inventor

Kanagawa, Japan

Residence of second inventor

Hayata Lugmoto Signature of second inventor

Date of this assignment

Kazumi ASADA Name of third inventor	
Kanagawa, Japan Residence of third inventor	
HARUMA Acada	0//08/2003
Kazumi Asada Signature of third inventor	Date of this assignment
•	
Tomoko SUZUKI Name of fourth inventor	
Tokyo, Japan Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Toshitaka HIRAGA Name of fifth inventor	
Kanagawa, Japan Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment
Tetsuo AOYAMA Name of sixth inventor	
Kanagawa, Japan Residence of sixth inventor	
Signature of sixth inventor	Date of this assignment

Kazumi ASADA Name of third inventor	
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Signature of third inventor	Date of this assignment
Tomoko SUZUKI Name of fourth inventor	
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Signature of fourth inventor	2003, 8, 7 Date of this assignment
Toshitaka HIRAGA Name of fifth inventor	
Kanagawa, Japan Residence of fifth inventor	
Joshi Life Chagy. Signature of fifth inventor	2003. 8.11 Date of this assignment
Tetsuo AOYAMA Name of sixth inventor	
Kanagawa, Iapan Residence of sixth inventor	
TII	

Tetsuo Aoyama Signature of sixth inventor

RECORDED: 08/14/2003

Date of this assignment